



#### 100V P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> T <sub>A</sub> = +25°C
100V	4.2Ω @ V <sub>GS</sub> = -10V	-0.27A
1000	5.0Ω @ V <sub>GS</sub> = -4.0V	-0.24A

#### **Description**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

## **Applications**

- DC-DC Converters
- Power Management Functions
- · Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

SOT23





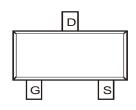
Top View

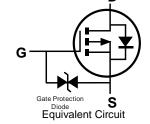
#### **Features and Benefits**

- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)





Top View Pin Configuration

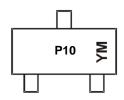
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMP10H4D2S-7	SOT23	3,000/Tape & Reel
DMP10H4D2S-13	SOT23	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



P10 = Product Type Marking Code YM = Date Code Marking Y or Y = Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code Key

Year	2015		2016	2017		2018	2019		2020	2021		2022
Code	С		D	E		F	G		Н	ı		J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



## **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	$V_{DSS}$	-100	V		
Gate-Source Voltage	$V_{GSS}$	±20	V		
Continuous Drain Current (Note 6) $V_{GS} = -10V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			I <sub>D</sub>	-0.27 -0.21	А
Pulsed Drain Current (10µs Pulse, Duty Cycle ≤1%)	$I_{DM}$	-1.0	Α		
Maximum Body Diode Continuous Current (Note 6)	•	•	Is	-0.42	Α

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units			
Total Dawer Dissination		(Note 5)	Б	0.38	W	
Total Power Dissipation		(Note 6)	$P_{D}$	0.44	۷V	
Thermal Resistance, Junction to Ambient Steady		(Note 5)	$R_{\theta JA}$	333		
Thermal Resistance, Junction to Ambient State		(Note 6)	$R_{\theta JA}$	282	°C/W	
Thermal Resistance, Junction to Case			R <sub>θJC</sub>	115		
Operating and Storage Temperature Range			$T_J,T_STG$	-55 to +150	°C	

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

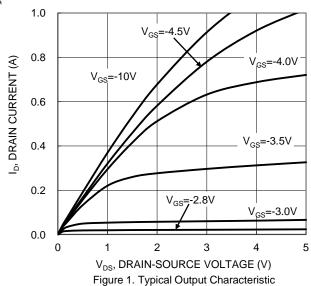
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						1
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-100	_	—	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = -100V, V_{GS} = 0V$
Gate-Body Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(TH)}$	-1.0	-2.3	-3.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance			2.8	4.2	Ω	$V_{GS} = -10V, I_D = -0.5A$
Static Drain-Source On-Nesistance	R <sub>DS(ON)</sub>	_	3.2	5.0	32	$V_{GS} = -4.0V, I_{D} = -0.1A$
Diode Forward Voltage	$V_{SD}$	_	-0.82	-1.3	V	$V_{GS} = 0V, I_{S} = -0.2A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C <sub>iss</sub>	_	87	_		V <sub>DS</sub> = -25V, V <sub>GS</sub> = 0V, f = 1.0MHz
Output Capacitance	Coss	_	5.6	_	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	2.9	_		
Gate Resistance	R <sub>G</sub>	_	15.3	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	Qg		1.8	_		
Gate-Source Charge	Q <sub>gs</sub>	_	0.3	_	nC	$V_{DS} = -80V, V_{GS} = -10V,$ $I_{D} = -0.5A$
Gate-Drain Charge	$Q_gd$	_	0.5	_		ID = -0.5A
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.3	_		
Turn-On Rise Time	t <sub>R</sub>	_	2.6	_		$V_{DS} = -50V, I_{D} = -0.5A,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	8.4	_	ns	$V_{GS} = -10V, R_{G} = 10\Omega$
Turn-Off Fall Time	t <sub>F</sub>	_	4.9	_		
Reverse Recovery Time	t <sub>RR</sub>	_	17.8	_	ns	$V_R = -100V$ , $I_F = -1.0A$ , $di/dt =$
Reverse Recovery Charge	Q <sub>rr</sub>	_	24.8	_	nC	100A/μs

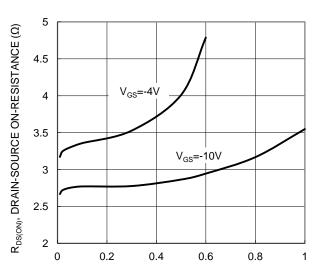
Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- Device mounted on FR-4 substrate PC board, 202 copper, with 1inch square copper pad layout.
  Short duration pulse test used to minimize self-heating effect.
  Guaranteed by design. Not subject to production testing.



#### DMP10H4D2S





I<sub>D</sub>, DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

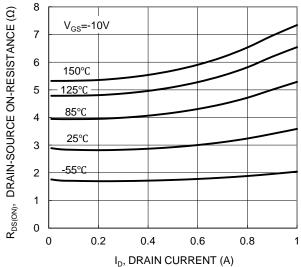
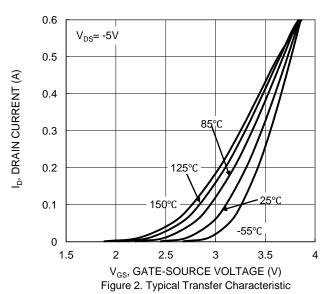
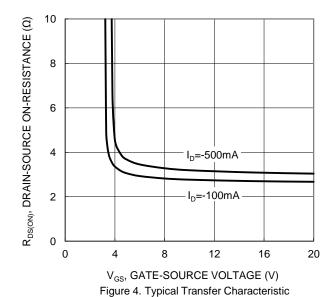


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





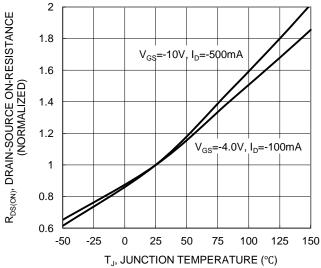
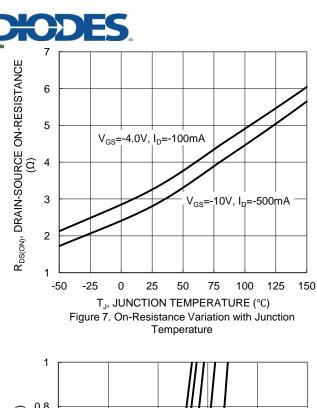
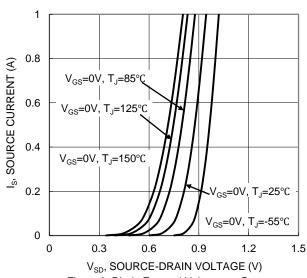
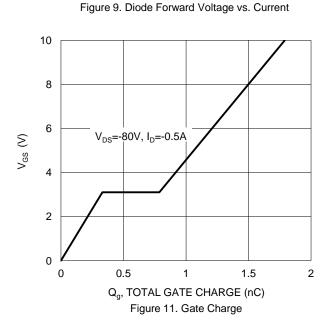


Figure 6. On-Resistance Variation with Junction Temperature







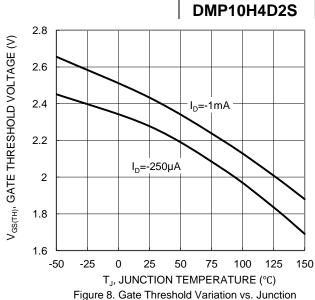
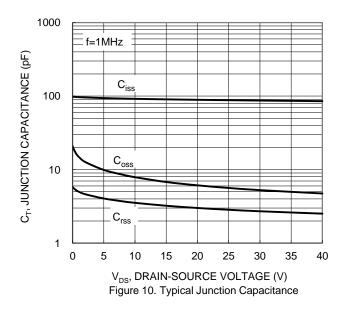
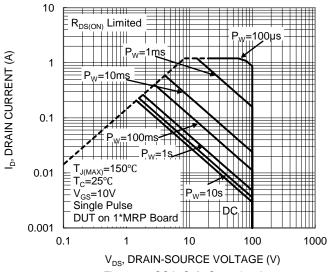
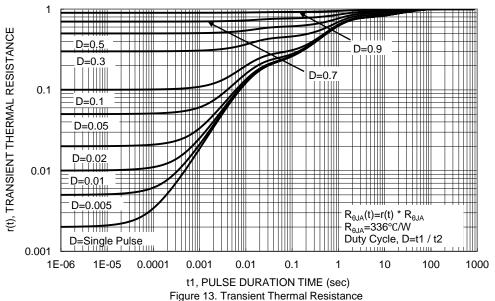


Figure 8. Gate Threshold Variation vs. Junction Temperature



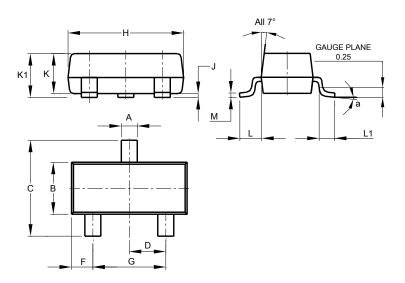






## **Package Outline Dimensions**

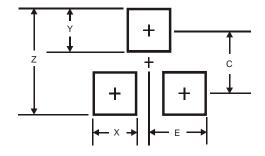
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80 3.00		2.90			
7	0.013 0.10		0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
١	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	8°					
All Dimensions in mm						

### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimension	Value (in mm)
s	
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35



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